2SJ0536

Silicon P-channel MOSFET

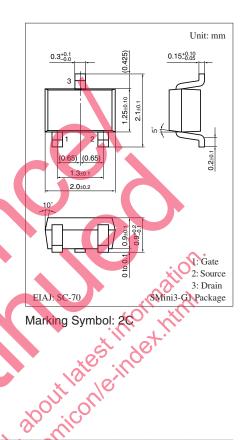
Secondary battery packs (Li ion battery, etc.) For switching circuits

Features

- High-speed switching
- S-mini type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing
- Low voltage drive (V_{th}: -1.0 V to 2.0 V)
- Low ON resistance

Absolute Maximum Ratings $T_a = 25^{\circ}C$

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Parameter	Symbol	Rating	Unit			
Drain-sourse surrender voltage	V _{DSS}	-30	V			
Gate-source voltage (Drain open)	V _{GSO}	±20	V			
Drain current	I _D	-100	mA			
Peak drain current	I _{DP}	-200	mA			
Power dissipation	PD	150	mW			
Channel temperature	T _{ch}	150	°C			
Storage temperature	T _{stg}	-55 to +150	°C			



Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

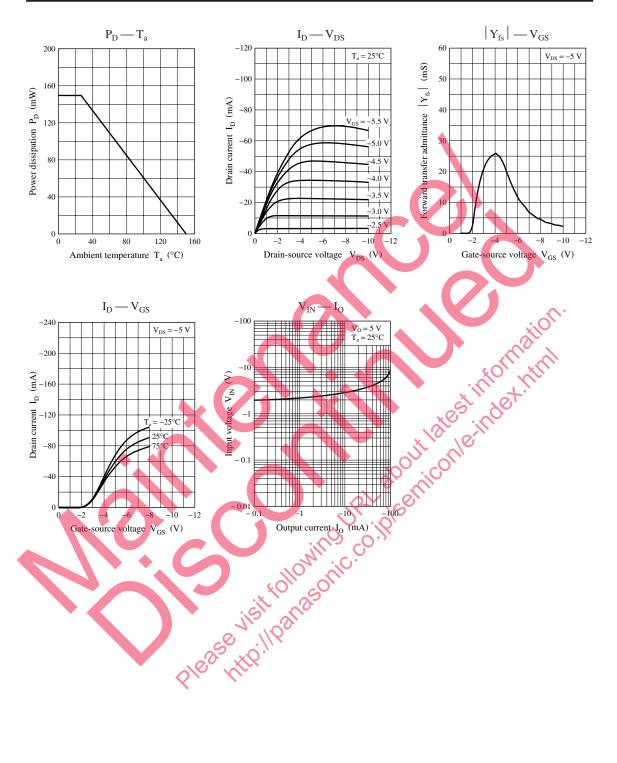
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Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Drain-source cutoff current	I _{DSS}	$V_{\rm DS} = -30 \text{ V}, V_{\rm GS} = 0$			- 0.1	μΑ
Gate-source cutoff current	I _{GSS}	$V_{\rm GS} = \pm 20 \text{ V} \cdot V_{\rm DS} = 0^{-10}$			±1.0	μΑ
Gate threshold voltage	V _{th}	$V_{DS} = -5V$, $I_D = -1\mu A$	-1.0		-2.0	V
Forward transfer admittance	$ Y_{\rm fs} $	$V_{DS} = -5 \text{ V}, I_{D} = -10 \text{ mA}$	8			mS
Drain-source ON resistance	R _{DS(on)}	$V_{GS} = -5$ V, $I_D = -10$ mA		50	75	Ω
Turn-on time	ton	$V_{DD} \rightarrow 5 \text{ V}, $		100		μs
	0	$R_{l} = 200 \Omega$				
Turn-off time	A _{off}	$V_{DD} = -5 \text{ V}, \text{ V}_{GS} = -5 \text{ V} \sim 0 \text{ V}$		25		μs
		$R_L = 200 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Observe precautions for handling. Electrostatic sensitive devices.

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